

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT
NATURE OF CONVEYANCE:	Corrective Assignment to correct the Assignors' information to include the fourth inventor, Atsushi INOUE, previously recorded on Reel 024811 Frame 0680. Assignor(s) hereby confirms the executed Assignment.
CONVEYING PARTY DATA	
Name	Execution Date
Renu WADHWA	12/24/2009
Sunil KAUL	12/24/2009
Maki SHIOTA	01/05/2010
Atsushi INOUE	01/06/2010
RECEIVING PARTY DATA	
Name:	NATIONAL INSTITUTE OF ADVANCED INDUSTRIAL SCIENCE AND TECHNOLOGY
Street Address:	3-1, Kasumigaseki 1-chome, Chiyoda-ku
City:	Tokyo
State/Country:	JAPAN
Postal Code:	100-8921
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12602358
CORRESPONDENCE DATA	
Fax Number:	(202)293-7860
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Email:	CHUSSAIN@SUGHRUE.COM
Correspondent Name:	Sughrue Mion, PLLC
Address Line 1:	2100 Pennsylvania Avenue, NW
Address Line 2:	Suite 800
Address Line 4:	Washington, DISTRICT OF COLUMBIA 20037-3213
ATTORNEY DOCKET NUMBER:	Q116251
NAME OF SUBMITTER:	J. Warren Lytle, Jr.

OP \$40.00 12602358

Total Attachments: 7

source=Q116251_CORRECTIVE_ASSIGNMENT_PAPERS#page1.tif

source=Q116251_CORRECTIVE_ASSIGNMENT_PAPERS#page2.tif

source=Q116251_CORRECTIVE_ASSIGNMENT_PAPERS#page3.tif

source=Q116251_CORRECTIVE_ASSIGNMENT_PAPERS#page4.tif

source=Q116251_CORRECTIVE_ASSIGNMENT_PAPERS#page5.tif

source=Q116251_CORRECTIVE_ASSIGNMENT_PAPERS#page6.tif

source=Q116251_CORRECTIVE_ASSIGNMENT_PAPERS#page7.tif

PATENT ASSIGNMENT

Electronic Version v1.1
Stylesheet Version v1.108/10/2010
501257278

SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Renu WADHWA</td> <td>12/24/2009</td> </tr> <tr> <td>Sunil KAUL</td> <td>12/24/2009</td> </tr> <tr> <td>Maki SHIOTA</td> <td>01/05/2010</td> </tr> </tbody> </table>		Name	Execution Date	Renu WADHWA	12/24/2009	Sunil KAUL	12/24/2009	Maki SHIOTA	01/05/2010
Name	Execution Date								
Renu WADHWA	12/24/2009								
Sunil KAUL	12/24/2009								
Maki SHIOTA	01/05/2010								
RECEIVING PARTY DATA									
Name:	NATIONAL INSTITUTE OF ADVANCED INDUSTRIAL SCIENCE AND TECHNOLOGY								
Street Address:	3-1, Kasumigaseki 1-chome								
City:	Chiyoda-ku, Tokyo								
State/Country:	JAPAN								
Postal Code:	100-8921								
PROPERTY NUMBERS Total: 1									
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12602358</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12602358				
Property Type	Number								
Application Number:	12602358								
CORRESPONDENCE DATA									
Fax Number:	(202)293-7860								
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
Email:	CHUSSAIN@SUGHRUE.COM								
Correspondent Name:	SUGHRUE MION, PLLC								
Address Line 1:	2100 PENNSYLVANIA AVE., N.W.								
Address Line 2:	SUITE 800								
Address Line 4:	WASHINGTON, DISTRICT OF COLUMBIA 20037-3213								
ATTORNEY DOCKET NUMBER:	Q116251								
NAME OF SUBMITTER:	J. Warren Lytle, Jr.								
Total Attachments: 4 source=Q116251_ASSIGNMENT#page1.tif source=Q116251_ASSIGNMENT#page2.tif									

12602358
CH \$40.00

Attorney's Docket No.: _____

Assignment of Application

WHEREAS, I (WE) _____

Renu WADHWA, Sunil KAUL, Maki SHIOTA and Atsushi INOUE of
 all c/o National Institute of Advanced Industrial Science and Technology,
 Tsukuba Central 4, 1-1, Higashi 1-chome, Tsukuba-shi, Ibaraki 305-8562 Japan

_____, respectively,

have invented certain new and useful improvements in: _____

PARATOPE AND EPI TOPE OF ANTI-MORTALIN ANTIBODY

for which an application for Letters Patent was executed on _____

(Application No. **PCT/JP2008/059834**, filed **May 28, 2008**), and

WHEREAS, **NATIONAL INSTITUTE OF ADVANCED INDUSTRIAL
 SCIENCE AND TECHNOLOGY**

(hereinafter referred to as "ASSIGNEE") having a place of business at: _____

3-1, Kasumigaseki 1-chome, Chiyoda-ku, Tokyo 100-8921 Japan

is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries;

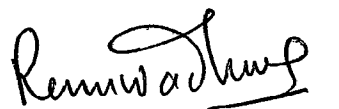
NOW, THEREFORE, in consideration of the sum of FIVE DOLLARS (\$5.00), the receipt whereof is hereby acknowledged, and for other good and valuable consideration, I (WE), by these presents do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, substitutions and renewals thereof.

I (WE) hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and any official of any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the assignee of my (our) entire right, title and interest in and to the same, for the sole use and behoof of said ASSIGNEE, its (his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me (us) had this Assignment and sale not been made.

Further, I (WE) agree that I (WE) will communicate to said ASSIGNEE or its legal representatives and assigns covenant and any facts known to me (us) respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letter Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its (his) successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.

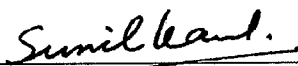
The undersigned hereby grant(s) the firm of SUGHRUE MION, PLLC, 2100 Pennsylvania Avenue, N.W., Washington, D.C. 20037-3213 U.S.A. the power to insert on this assignment any further identification, including the application number and filing date, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Date: Dec 24, 2009



(Signature of inventor) Renu WADHWA


Date: Dec 24, 2009



(Signature of inventor) Sunil KAUL

Date: Jan. 5, 2010 Maki Shiota
(Signature of inventor) Maki SHIOTA

Date: Jan. 6, 2010


(Signature of inventor) Atsushi INOUE